



N-Channel Enhancement-Mode Vertical DMOS FET

Features

- ▶ Free from secondary breakdown
- ▶ Low power drive requirement
- ▶ Ease of paralleling
- ▶ Low C_{iss} and fast switching speeds
- ▶ Excellent thermal stability
- ▶ Integral source-drain diode
- ▶ High input impedance and high gain
- ▶ Complementary N- and P-channel devices

Applications

- ▶ Logic level interfaces - ideal for TTL and CMOS
- ▶ Solid state relays
- ▶ Battery operated systems
- ▶ Photo-voltaic drives
- ▶ Analog switches
- ▶ General purpose line drivers
- ▶ Telecom switches

General Description

This low threshold, enhancement-mode (normally-off) transistor utilizes a vertical DMOS structure and Supertex's well-proven, silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors and the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Ordering Information

Device	Package Option		BV_{DSS}/BV_{DGS} (V)	$R_{DS(ON)}$ (max) (Ω)	$V_{GS(th)}$ (max) (V)
	TO-236AB (SOT-23)	TO-92			
TN2106	TN2106K1-G	TN2106N3-G	60	2.5	2.0

-G indicates package is RoHS compliant ('Green')



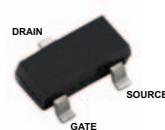
Absolute Maximum Ratings

Parameter	Value
Drain-to-source	BV_{DSS}
Drain-to-gate	BV_{DGS}
Gate-to-source	$\pm 20V$
Operating and storage temperature	-55°C to +150°C
Soldering temperature*	300°C

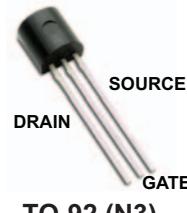
Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

* Distance of 1.6mm from case for 10 seconds.

Pin Configurations



TO-236AB (SOT-23) (K1)



TO-92 (N3)

Product Marking

N1LW

W = Code for week sealed

_____ = "Green" Packaging

TO-236AB (SOT-23) (K1)



YY = Year Sealed

WW = Week Sealed

_____ = "Green" Packaging

TO-92 (N3)

Thermal Characteristics

Package	I_D (continuous) ^f (mA)	I_D (pulsed) (A)	Power Dissipation @ $T_A = 25^\circ\text{C}$ (W)	θ_{jc} ($^\circ\text{C}/\text{W}$)	θ_{ja} ($^\circ\text{C}/\text{W}$)	I_{DR}^f (mA)	I_{DRM} (A)
TO-236AB (SOT-23)	280	0.8	0.36	200	350	280	0.8
TO-92	300	1.0	0.74	125	170	300	1.0

Notes:

^f I_D (continuous) is limited by max rated T_j .

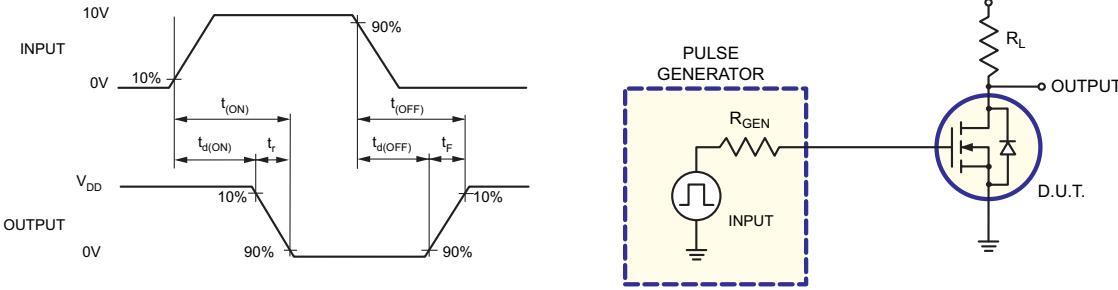
Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise specified)

Sym	Parameter	Min	Typ	Max	Units	Conditions
BV_{DSS}	Drain-to-source breakdown voltage	60	-	-	V	$V_{GS} = 0\text{V}$, $I_D = 1.0\text{mA}$
$V_{GS(\text{th})}$	Gate threshold voltage	0.6	-	2.0	V	$V_{GS} = V_{DS}$, $I_D = 1.0\text{mA}$
$\Delta V_{GS(\text{th})}$	Change in $V_{GS(\text{th})}$ with temperature	-	-3.8	-5.5	mV/ $^\circ\text{C}$	$V_{GS} = V_{DS}$, $I_D = 1.0\text{mA}$
I_{GSS}	Gate body leakage	-	0.1	100	nA	$V_{GS} = \pm 20\text{V}$, $V_{DS} = 0\text{V}$
I_{DSS}	Zero gate voltage drain current	-	-	1.0	μA	$V_{GS} = 0\text{V}$, V_{DS} = Max Rating
		-	-	100	μA	$V_{DS} = 0.8\text{Max Rating}$, $V_{GS} = 0\text{V}$, $T_A = 125^\circ\text{C}$
$I_{D(\text{ON})}$	On-state drain current	0.6	-	-	A	$V_{GS} = 10\text{V}$, $V_{DS} = 25\text{V}$
$R_{DS(\text{ON})}$	Static drain-to-source on-state resistance	-	-	5.0	Ω	$V_{GS} = 4.5\text{V}$, $I_D = 200\text{mA}$
		-	-	2.5	Ω	$V_{GS} = 10\text{V}$, $I_D = 500\text{mA}$
$\Delta R_{DS(\text{ON})}$	Change in $R_{DS(\text{ON})}$ with temperature	-	0.70	1.0	%/ $^\circ\text{C}$	$V_{GS} = 10\text{V}$, $I_D = 500\text{mA}$
G_{FS}	Forward transductance	150	400	-	mmho	$V_{DS} = 25\text{V}$, $I_D = 500\text{mA}$
C_{ISS}	Input capacitance	-	35	50	pF	$V_{GS} = 0\text{V}$,
C_{OSS}	Common source output capacitance	-	17	25	pF	$V_{DS} = 25\text{V}$,
C_{RSS}	Reverse transfer capacitance	-	7.0	8.0	pF	$f = 1.0\text{MHz}$
$t_{d(\text{ON})}$	Turn-on delay time	-	3.0	5.0		
t_r	Rise time	-	5.0	8.0	ns	$V_{DD} = 25\text{V}$,
$t_{d(\text{OFF})}$	Turn-off delay time	-	6.0	9.0	ns	$I_D = 0.5\text{A}$,
t_f	Fall time	-	5.0	8.0	ns	$R_{\text{GEN}} = 25\Omega$
V_{SD}	Diode forward voltage drop	-	1.2	1.8	V	$V_{GS} = 0\text{V}$, $I_{SD} = 500\text{mA}$
t_{rr}	Reverse recovery time	-	400	-	ns	$V_{GS} = 0\text{V}$, $I_{SD} = 500\text{mA}$

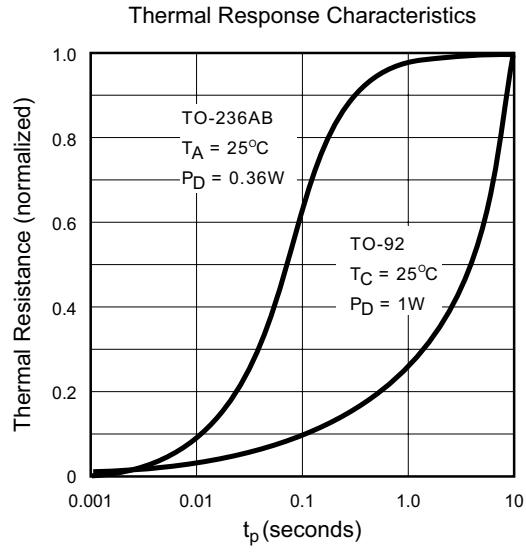
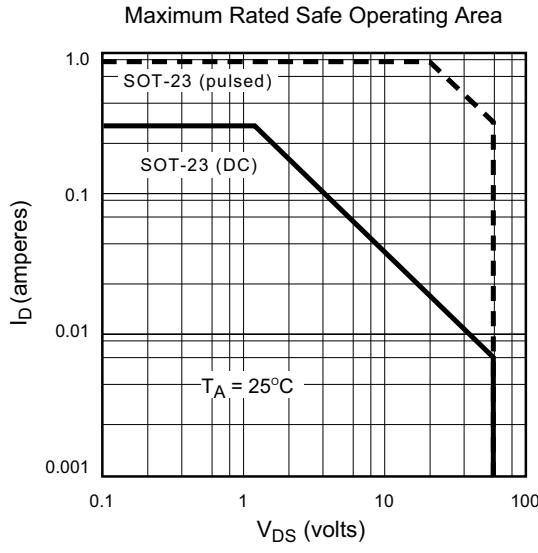
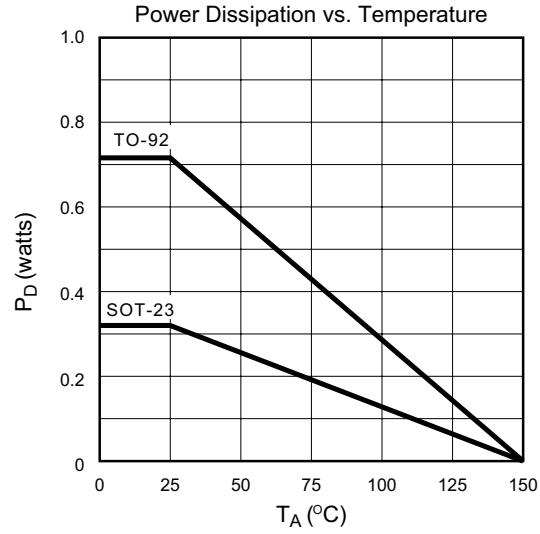
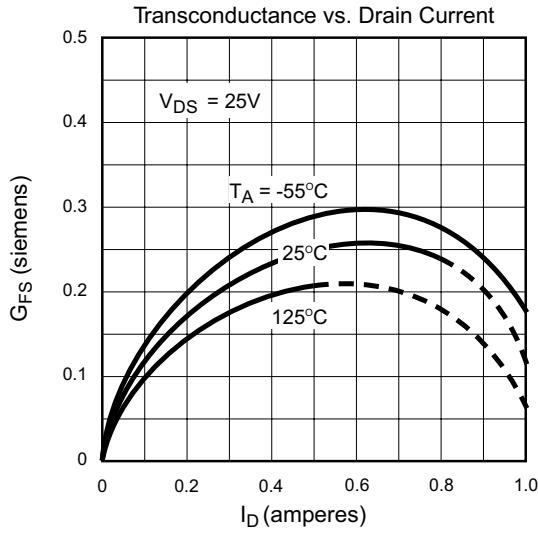
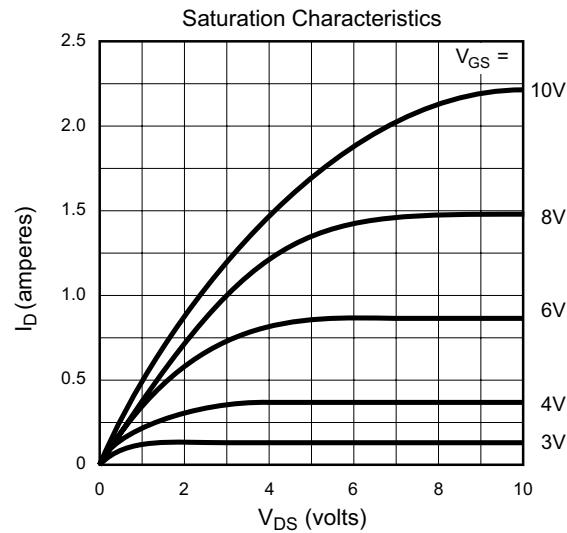
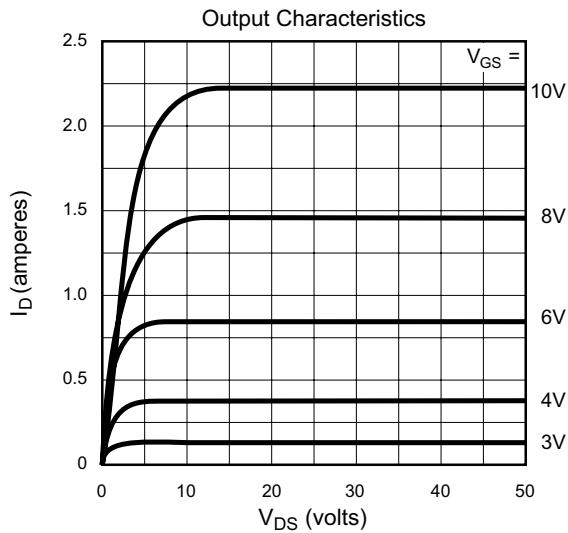
Notes:

- All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300 μs pulse, 2% duty cycle.)
- All A.C. parameters sample tested.

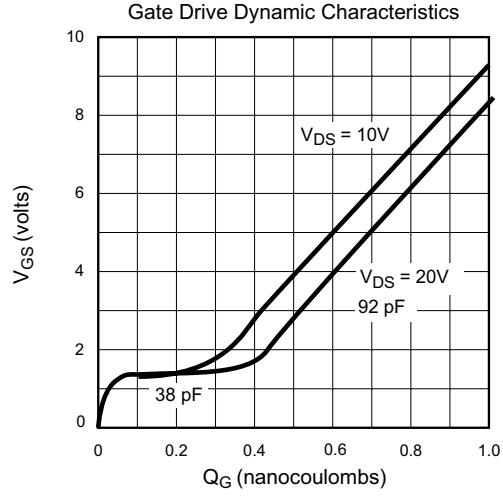
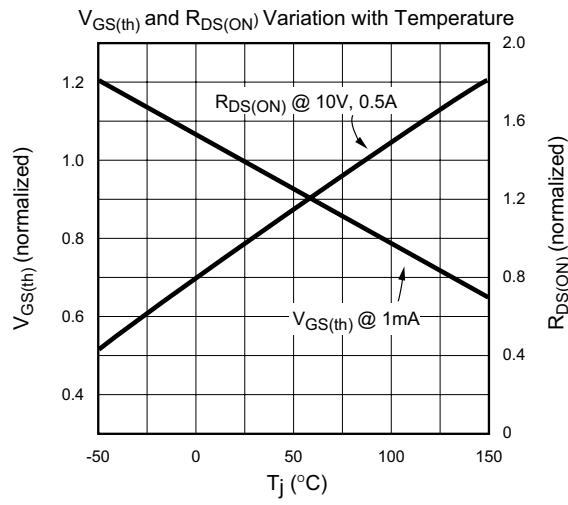
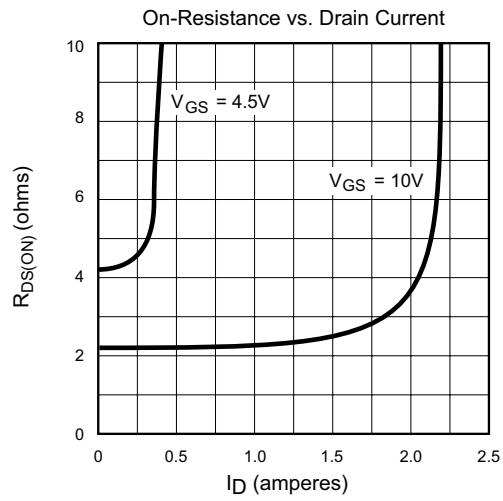
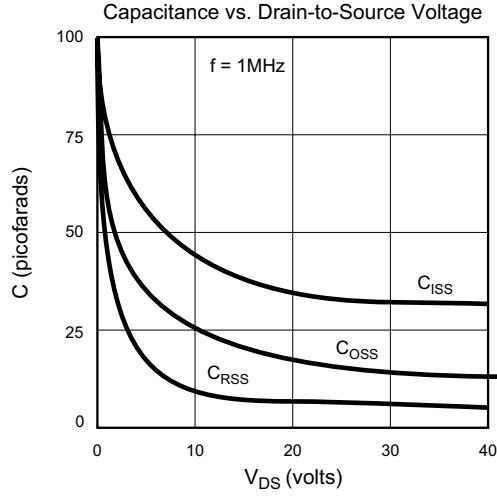
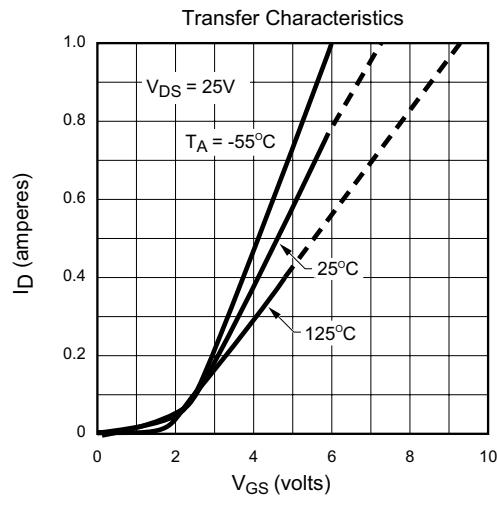
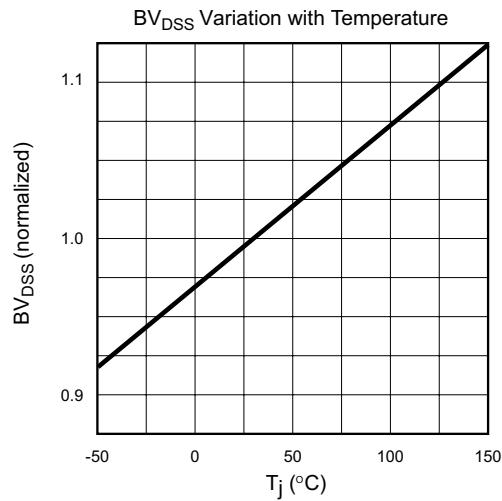
Switching Waveforms and Test Circuit



Typical Performance Curves

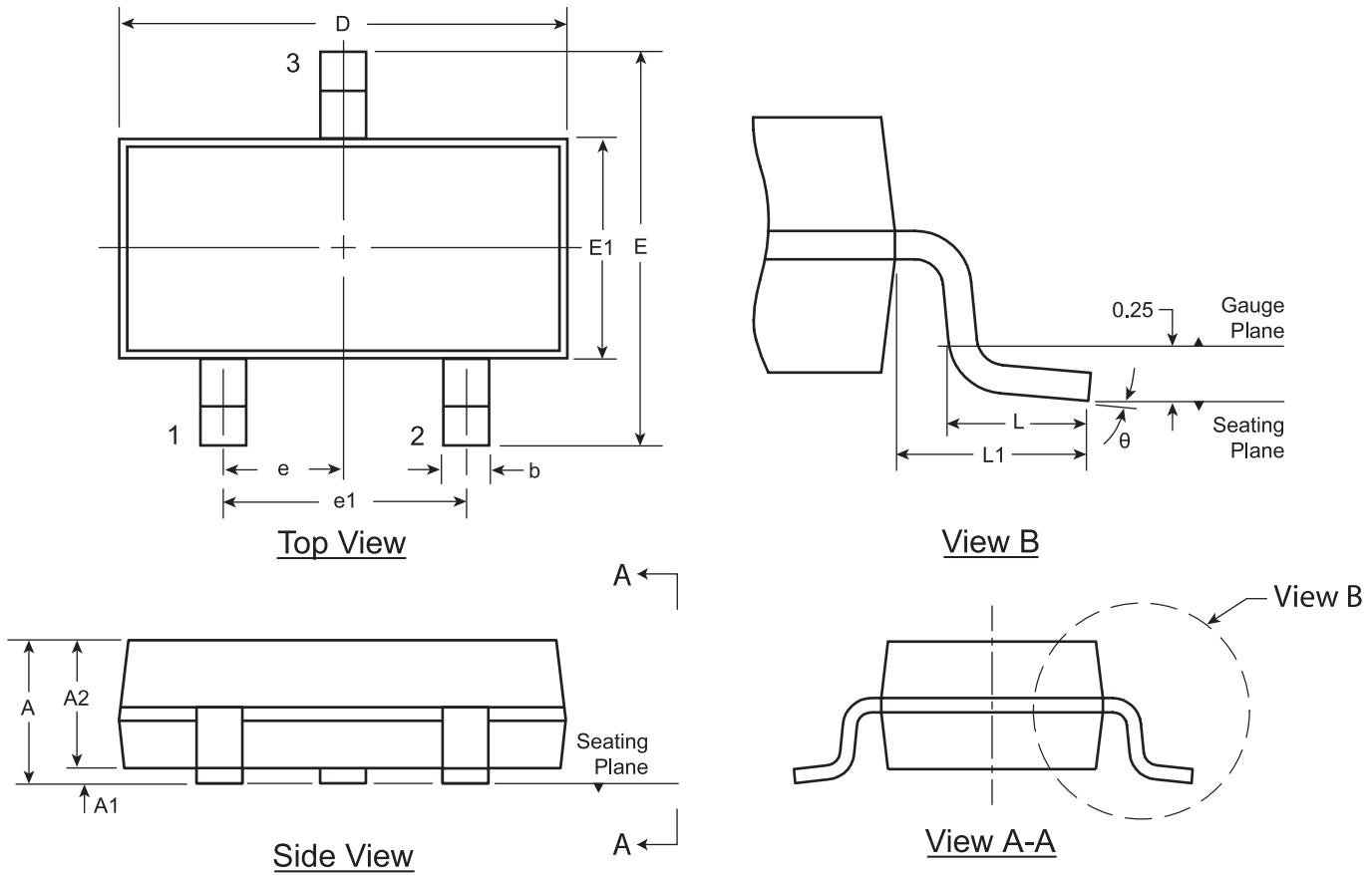


Typical Performance Curves (cont.)



3-Lead TO-236AB (SOT-23) Package Outline (K1)

2.90x1.30mm body, 1.12mm height (max), 1.90mm pitch

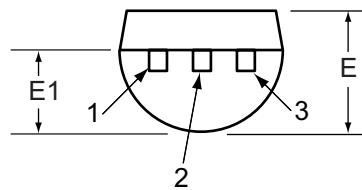
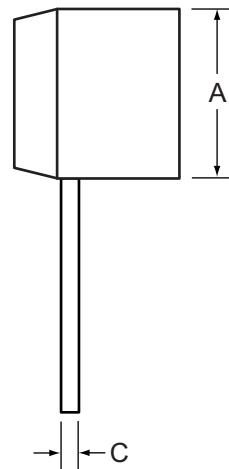
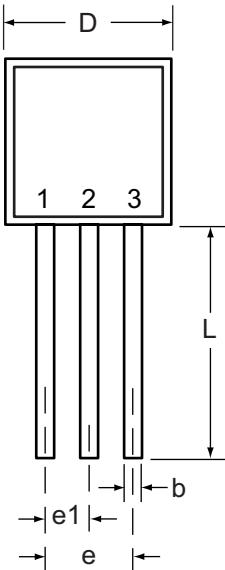


Symbol		A	A1	A2	b	D	E	E1	e	e1	L	L1	θ
Dimension (mm)	MIN	0.89	0.01	0.88	0.30	2.80	2.10	1.20	0.95 BSC	1.90 BSC	0.40	0.54 REF	0°
	NOM	-	-	0.95	-	2.90	-	1.30			0.50		-
	MAX	1.12	0.10	1.02	0.50	3.04	2.64	1.40			0.60		8°

JEDEC Registration TO-236, Variation AB, Issue H, Jan. 1999.

Drawings not to scale.

3-Lead TO-92 Package Outline (N3)



Symbol		A	b	c	D	E	E1	e	e1	L
Dimension (inches)	MIN	.170	.014	.014	.175	.125	.080	.095	.045	.500
	NOM	-	-	-	-	-	-	-	-	-
	MAX	.210	.022	.022	.205	.165	.105	.105	.055	-

Drawings not to scale.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <http://www.supertex.com/packaging.html>.)

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Supertex Inc.
1235 Bordeaux Drive, Sunnyvale, CA 94089
TEL: (408) 222-8888 / FAX: (408) 222-4895
www.supertex.com